TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (U-MOS III)

SSM6N15AFU

Load Switching Applications

Unit: mm

- 2.5 V drive
- N-ch 2-in-1
- Low ON-resistance: $R_{DS(ON)}$ = 3.6 Ω (max) (@V_{GS} = 4.0 V) $R_{DS(ON)} = 6.0 \Omega \text{ (max) (@V_{GS} = 2.5 V)}$

Absolute Maximum Ratings (Ta = 25°C) (Q1, Q2 Common)

Characteristics		Symbol	Rating	Unit	
Drain-Source voltage		V_{DSS}	30	V	
Gate-Source voltage		V_{GSS}	±20	V	
Drain current	DC	ID	100	mA	
	Pulse	I _{DP}	400		
Power dissipation		P _D (Note 1)	300	mW	
Channel temperature		T _{ch}	150	°C	
Storage temperature range		T _{stg}	-55 to 150	°C	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e.

A 1 Ⅲ 2 Ⅲ +0.1 −0.05 ⊕ 0.1 ⊗ A 0.65 0.6 1.Source1 4.Source2 US6 2.Gate1 5.Gate2 3.Drain2 6.Drain1 **JEDEC** JEITA SC-88 **TOSHIBA** 2-2J1C

Weight: 6.8 mg (typ.)

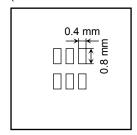
operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Total rating

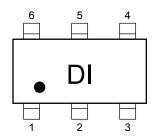
Mounted on FR4 board

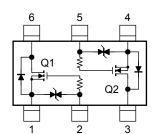
 $(25.4 \text{ mm} \times 25.4 \text{ mm} \times 1.6 \text{ mm}, \text{ Cu Pad: } 0.32 \text{mm}^2 \times 6)$



Marking

Equivalent Circuit (top view)





Start of commercial production 2010-11

Electrical Characteristics (Ta = 25°C) (Q1, Q2 Common)

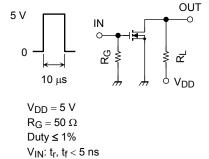
Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Drain-Source breakdown voltage		V (BR) DSS	$I_D = 0.1 \text{ mA}, V_{GS} = 0 \text{ V}$	30	_	_	V
		V (BR) DSX	$I_D = 0.1 \text{ mA}, V_{GS} = -10 \text{ V}$ (Note 3)	16	_	_	
Drain cut-off current		I _{DSS}	V _{DS} = 30 V, V _{GS} = 0 V	_	_	1	μА
Gate leakage current		I _{GSS}	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0 \text{ V}$	_	_	±1	μА
Gate threshold voltage	е	V _{th}	$V_{DS} = 3 \text{ V}, I_D = 0.1 \text{ mA}$	0.8	_	1.5	V
Forward transfer admittance		Y _{fS}	$V_{DS} = 3 \text{ V}, I_D = 10 \text{ mA}$ (Note 2)	35	_	_	mS
Drain-Source ON resistance		R _{DS} (ON)	$I_D = 10 \text{ mA}, V_{GS} = 4 \text{ V}$ (Note 2)	_	2.3	3.6	Ω
			$I_D = 10 \text{ mA}, V_{GS} = 2.5 \text{ V}$ (Note 2)	_	3.5	6.0	
Input capacitance		C _{iss}	V _{DS} = 3 V, V _{GS} = 0 V, f = 1 MHz	_	13.5	_	pF
Output capacitance		Coss		_	8.0	_	
Reverse transfer capacitance		C _{rss}		_	6.5	_	
Switching time	Turn-on time	t _{on}	$V_{DD} = 5 \text{ V}, I_D = 10 \text{ mA},$ $V_{GS} = 0 \text{ to } 5 \text{ V}, R_G = 50 \Omega$	_	5.5	_	ns
	Turn-off time	t _{off}		_	35	_	
Drain-source forward voltage		V _{DSF}	$I_D = -100 \text{ mA}, V_{GS} = 0 \text{ V}$ (Note 2)	_	-0.85	-1.2	V

Note 2: Pulse test

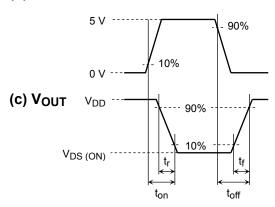
Note 3: If a reverse bias is applied between gate and source, this device enters V(BR)DSX mode. Note that the drain-source breakdown voltage is lowered in this mode.

Switching Time Test Circuit





(b) V_{IN}



Precaution

 V_{th} can be expressed as voltage between gate and source when low operating current value is I_D = 0.1 mA for this product. For normal switching operation, V_{GS} (on) requires higher voltage than V_{th} and V_{GS} (off) requires lower voltage than V_{th} . (Relationship can be established as follows: V_{GS} (off) < V_{th} < V_{GS} (on))

Please take this into consideration for using the device.

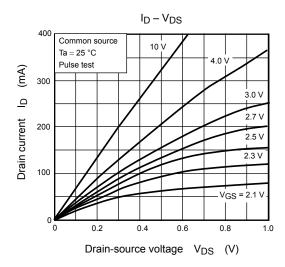
Common Source Ta = 25°C

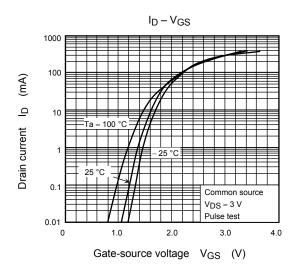
Do not use this device under avalanche mode. It may cause the device to break down.

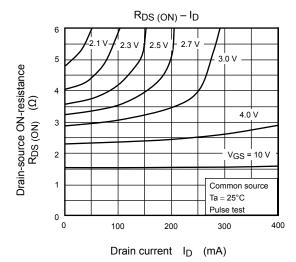
Handling Precaution

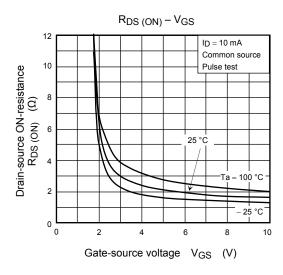
When handling individual devices (which are not yet mounting on a circuit board), be sure that the environment is protected against electrostatic electricity. Operators should wear anti-static clothing, and containers and other objects that come into direct contact with devices should be made of anti-static materials.

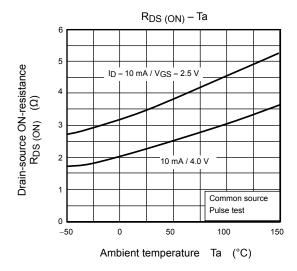
Thermal resistance $R_{th(ch-a)}$ and power dissipation P_D vary depending on board material, board area, board thickness and pad area. When using this device, please take heat dissipation into consideration

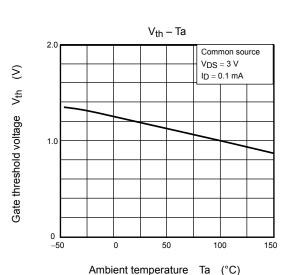




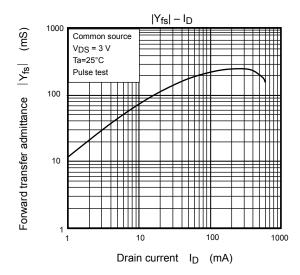


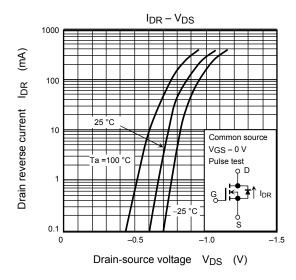


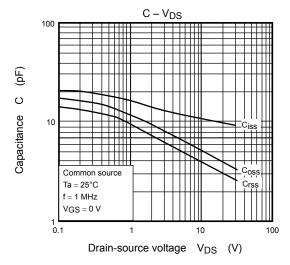


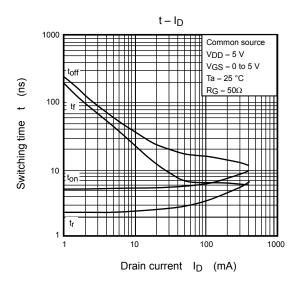


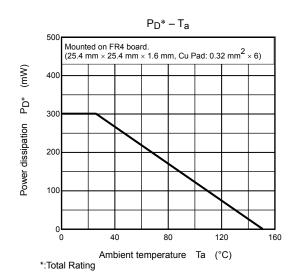
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